



# Product Change Notification

**Change Notification #:** 116451 - 00  
**Change Title:** Select Intel® SSD Pro 7600p and Intel® SSD 760p Series Products, PCN 116451-00, Product Design, Firmware Update  
**Date of Publication:** August 29, 2018

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	September 14, 2018
-------------------------------------------------------------------------	--------------------

## Description of Change to the Customer:

The Intel® SSD Pro 7600p and Intel® SSD 760p Series Products firmware version is being updated.

These Products firmware will update from 001C to 004C.

SSDPEKKW128G801  
SSDPEKKW256G801  
SSDPEKKW512G801  
SSDPEKKW128G8XT  
SSDPEKKW256G8XT  
SSDPEKKW512G8XT  
SSDPEKKW010T8X1

This Products firmware will update from 002C to 004C.

SSDPEKKW020T8X1

These Products firmware will update from 001P to 004P.

SSDPEKKF128G8X1  
SSDPEKKF256G8X1  
SSDPEKKF512G8X1  
SSDPEKKF010T8X1

This Products firmware will update from 002P to 004P.

SSDPEKKF020T8X1

## Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel does not expect any impact to customers from these changes.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD 760p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW128G8XT	963289	J81569-100	J85742-100	J81569-101	J85742-101
Intel® SSD 760p Series (128GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW128G801	963928	J85749-100	J85742-100	J85749-101	J85742-101
Intel® SSD 760p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW256G8XT	963290	J81570-100	J85743-100	J81570-101	J85743-101
Intel® SSD 760p Series (256GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW256G801	963929	J85750-100	J85743-100	J85750-101	J85743-101
Intel® SSD 760p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW512G8XT	963291	J81571-100	J85744-100	J81571-101	J85744-101
Intel® SSD 760p Series (512GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW512G801	963930	J85751-100	J85744-100	J85751-101	J85744-101
Intel® SSD 760p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW010T8X1	962568	J77033-100	J77035-100	J77033-101	J77035-101
Intel® SSD 760p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW020T8X1	962569	J77034-101	J77036-101	J77034-102	J77036-102
Intel® SSD Pro 7600p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF128G8X1	963303	J83886-100	J83893-100	J83886-101	J83893-101
Intel® SSD Pro 7600p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF256G8X1	963304	J83887-100	J83895-100	J83887-101	J83895-101
Intel® SSD Pro 7600p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF512G8X1	963305	J83888-100	J83896-100	J83888-101	J83896-101
Intel® SSD Pro 7600p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF010T8X1	963306	J83892-100	J83898-100	J83892-101	J83898-101
Intel® SSD Pro 7600p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF020T8X1	963307	J83890-101	J83897-101	J83890-102	J83897-102

## PCN Revision History:

**Date of Revision:**  
August 29, 2018

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



# Product Change Notification

## 116451 - 00

**INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

Copyright © Intel Corporation 2018. Other names and brands may be claimed as the property of others.

3D XPoint, Axxia, Basis, Basis Peak, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, Curie, Flexpipe, Intel, the Intel logo, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Inside, the Intel Inside logo, Intel Insider, Intel Joule, Intel RealSense, Intel SingleDriver, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Iris, Itanium, MCS, MMX, Optane, Ostro, Pali, Pentium, picoArray, Picochip, picoXcell, Puma, Quark, SMARTi, Soletta, Sound Mark, StarPro, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcende, True Key, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS® Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos. Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.